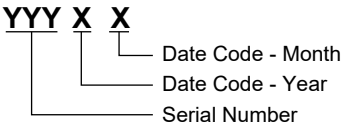
PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM8951	SOT-23-5	-40℃ to +85℃	SGM8951YN5G/TR	SBEXX	Tape and Reel, 3000
	SOIC-8	-40℃ to +85℃	SGM8951YS8G/TR	SGM 8951YS8 XXXXX	Tape and Reel, 2500
SGM8952	SOIC-8	-40℃ to +85℃	SGM8952YS8G/TR	SGM 8952YS8 XXXXX	Tape and Reel, 2500
	MSOP-8	-40℃ to +85℃	SGM8952YMS8G/TR	SGM8952 YMS8 XXXXX	Tape and Reel, 3000

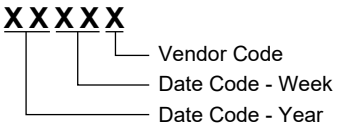
MARKING INFORMATION

NOTE: XX = Date Code. XXXXX = Date Code and Vendor Code.

SOT-23-5



SOIC-8/MSOP-8



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $+V_S$ to $-V_S$ 6V
Voltage at Input/Output Pins
..... $(-V_S)$ - 0.3V to $(+V_S)$ + 0.3V
Input Common Mode Voltage Range
..... $(-V_S)$ - 0.1V to $(+V_S)$ + 0.1V
Junction Temperature ..... +150℃
Storage Temperature Range ..... -65℃ to +150℃
Lead Temperature (Soldering, 10s) ..... +260℃
ESD Susceptibility
HBM 8000V
MM 400V

RECOMMENDED OPERATING CONDITIONS

Operating Temperature Range ..... -40℃ to +85℃

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

ESD SENSITIVITY CAUTION

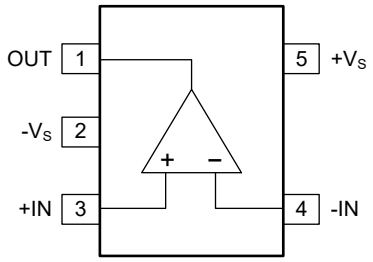
This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

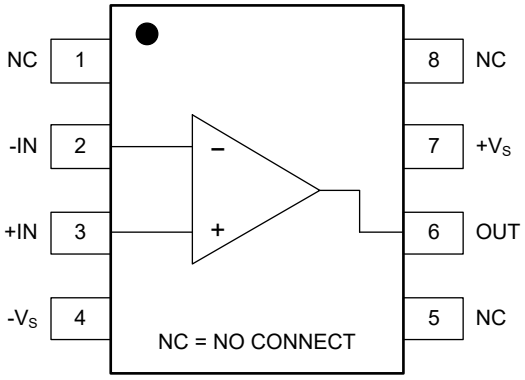
PIN CONFIGURATIONS

SGM8951 (TOP VIEW)



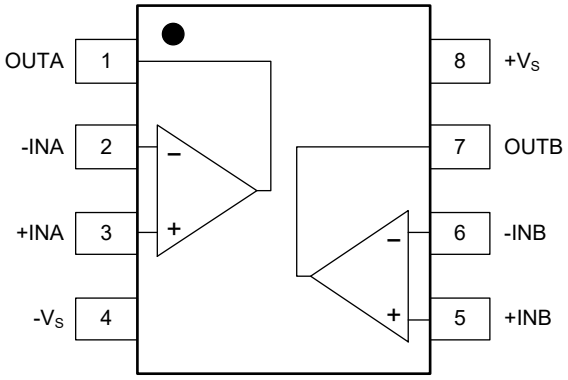
SOT-23-5

SGM8951 (TOP VIEW)



SOIC-8

SGM8952 (TOP VIEW)



SOIC-8/MSOP-8

ELECTRICAL CHARACTERISTICS

(At T_A = +25℃, V_S = 5V, R_L = 100kΩ connected to V_S/2 and V_{OUT} = V_S/2, Full = -40℃ to +85℃, unless otherwise noted.)

PARAMETER		CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
DC Performance							
Input Offset Voltage (V_{OS})		V_{CM} = V_S/2	+25℃		0.2	0.8	mV
			Full			1.2	
Open-Loop Voltage Gain (A_{OL})		R_L = 10kΩ, V_{OUT} = 0.15V to 4.85V	+25℃	78	90		dB
			Full	73			
		R_L = 100kΩ, V_{OUT} = 0.05V to 4.95V	+25℃		92		
Input Characteristics							
Input Common Mode Voltage Range (V_{CM})			+25℃	-0.1		5.1	V
Common Mode Rejection Ratio (CMRR)		V_{CM} = -0.1V to 5.1V	+25℃	77	92		dB
			Full	73			
Output Characteristics							
Output Voltage Swing from Rail		R_L = 2kΩ, V_{CM} = V_S/2	+25℃		78	94	mV
			Full			103	
		R_L = 10kΩ, V_{CM} = V_S/2	+25℃		16	28	
			Full			33	
Output Short-Circuit Current (I_{SC})		R_L = 10Ω to V_S/2	+25℃	25	32		mA
			Full	17			
Power Supply							
Operating Voltage Range				1.8		5.5	V
Quiescent Current	SGM8951	I_{OUT} = 0mA, V_{CM} = V_S/2	+25℃		26	35	μA
			Full			39	
	SGM8952	I_{OUT} = 0mA, V_{CM} = V_S/2	+25℃		34	48	
			Full			55	
Dynamic Performance (1)							
Gain-Bandwidth Product (GBP)		C_L = 100pF, R_L = 100kΩ	+25℃		110		kHz
Slew Rate		V_{OUT} = $2V_{P-P}$, A_V = 1	+25℃		45		V/ms
Noise/Distortion Performance							
Input Voltage Noise Density (e_n)		f = 1kHz	+25℃		115		nV/$\sqrt{Hz}$
Input Voltage Noise		f = 0.1Hz to 10Hz	+25℃		3.5		μV_{P-P}

NOTE: 1. Correct power supply bypassing is very important for optimizing SGM8951/2 performance. A 0.1μF and a 10μF capacitors are always used to bypass V_S pin of SGM8951/2. Please place these two capacitors as close to the SGM8951/2 V_S pin as possible. A large ground plane is also needed to ensure optimum performance.

ELECTRICAL CHARACTERISTICS (continued)

(At T_A = +25℃, V_S = 1.8V, R_L = 100kΩ connected to V_S/2 and V_{OUT} = V_S/2, Full = -40℃ to +85℃, unless otherwise noted.)

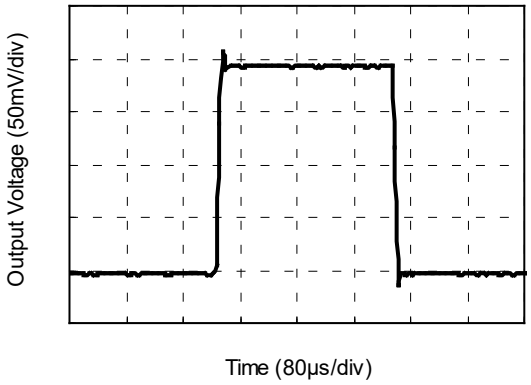
PARAMETER		CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
DC Performance							
Input Offset Voltage (V_{OS})		V_{CM} = V_S/2	+25℃		0.3	0.9	mV
			Full			1.25	
Open-Loop Voltage Gain (A_{OL})		R_L = 10kΩ, V_{OUT} = 0.15V to 1.65V	+25℃	83	100		dB
			Full	80			
		R_L = 100kΩ, V_{OUT} = 0.05V to 1.75V	+25℃		107		dB
Input Characteristics							
Input Common Mode Voltage Range (V_{CM})			+25℃	-0.1		1.9	V
Common Mode Rejection Ratio (CMRR)		V_{CM} = -0.1V to 1.9V	+25℃	73	89		dB
			Full	70			
Output Characteristics							
Output Voltage Swing from Rail		R_L = 2kΩ, V_{CM} = V_S/2	+25℃		49	69	mV
			Full			76	
		R_L = 10kΩ, V_{CM} = V_S/2	+25℃		11	23	
			Full			28	
Output Short-Circuit Current (I_{SC})		R_L = 10Ω to V_S/2	+25℃	0.9	4		mA
			Full	0.5			
Power Supply							
Quiescent Current	SGM8951	V_{CM} = V_S/2, I_{OUT} = 0mA	+25℃		22	30	μA
			Full			34	
	SGM8952	V_{CM} = V_S/2, I_{OUT} = 0mA	+25℃		30	43	
			Full			49	
Power Supply Rejection Ratio (PSRR)		V_S = 1.8V to 5.5V, V_{CM} = 0.5V	+25℃	74	80		dB
			Full	70			
Dynamic Performance (1)							
Gain-Bandwidth Product (GBP)		C_L = 100pF, R_L = 100kΩ	+25℃		100		kHz
Slew Rate		V_{OUT} = $1V_{P-P}$, A_V = 1	+25℃		40		V/ms
Noise/Distortion Performance							
Input Voltage Noise Density (e_n)		f = 1kHz	+25℃		115		nV/$\sqrt{Hz}$
Input Voltage Noise		f = 0.1Hz to 10Hz	+25℃		3.5		μV_{P-P}

NOTE: 1. Correct power supply bypassing is very important for optimizing SGM8951/2 performance. A 0.1μF and a 10μF capacitors are always used to bypass V_S pin of SGM8951/2. Please place these two capacitors as close to the SGM8951/2 V_S pin as possible. A large ground plane is also needed to ensure optimum performance.

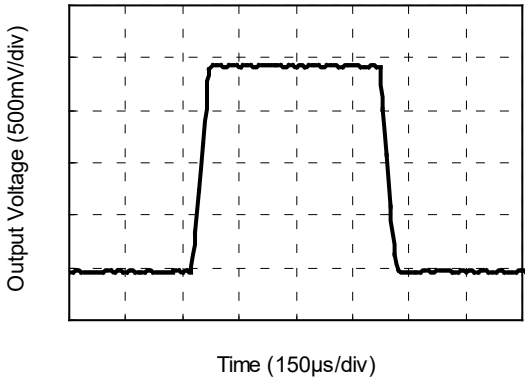
TYPICAL PERFORMANCE CHARACTERISTICS

At T_A = +25℃, V_S = 5V, unless otherwise noted.

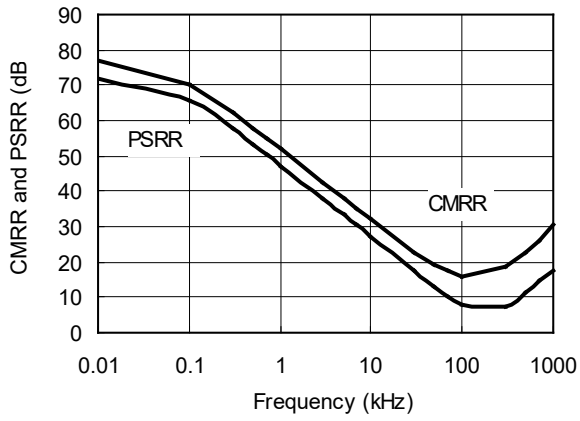
Small Signal Step Response



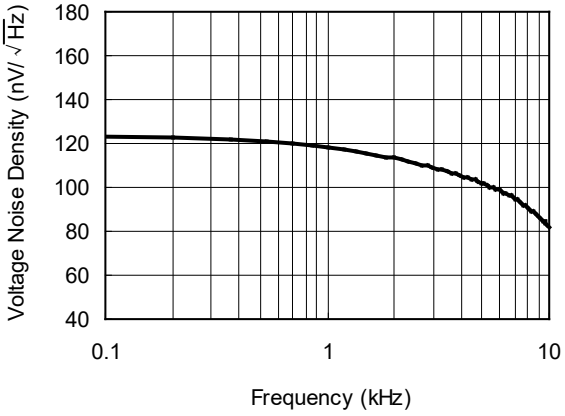
Large Signal Step Response



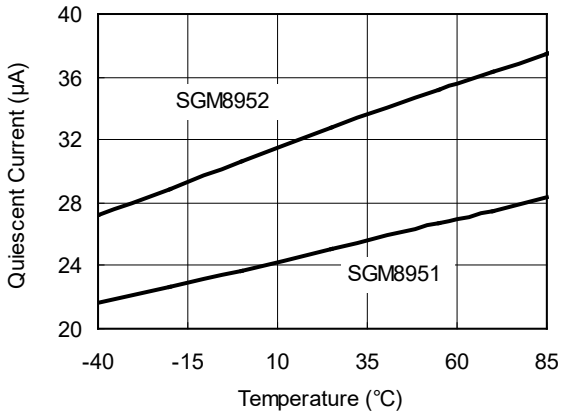
CMRR and PSRR vs. Frequency



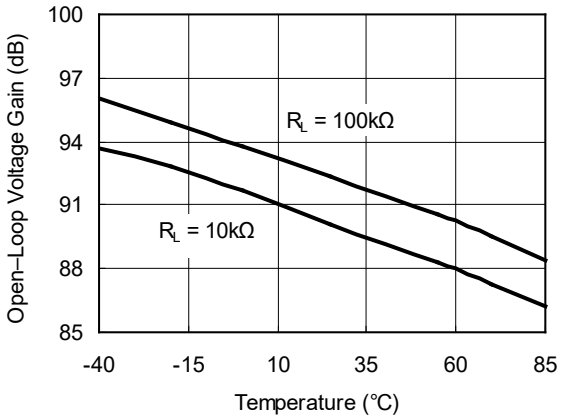
Voltage Noise Spectral Density
vs. Frequency



Quiescent Current vs. Temperature



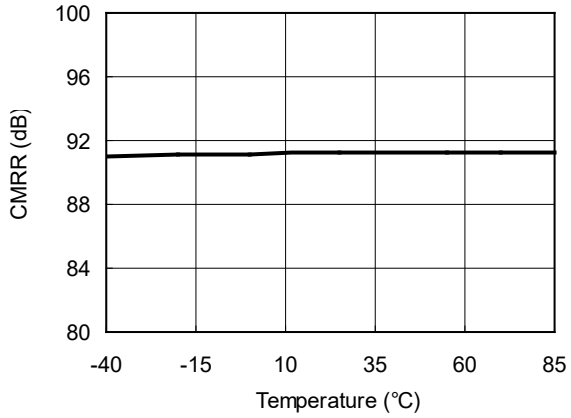
Open-Loop Voltage Gain vs. Temperature



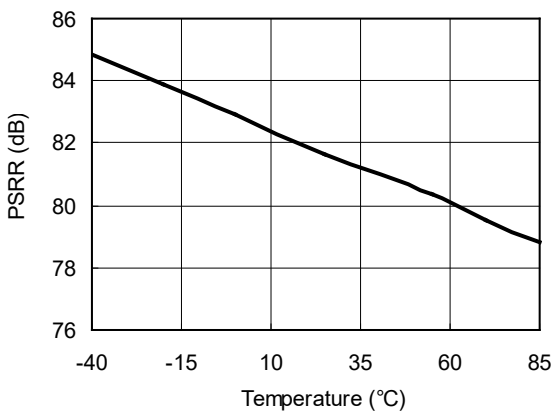
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

At T_A = +25℃, V_S = 5V, unless otherwise noted.

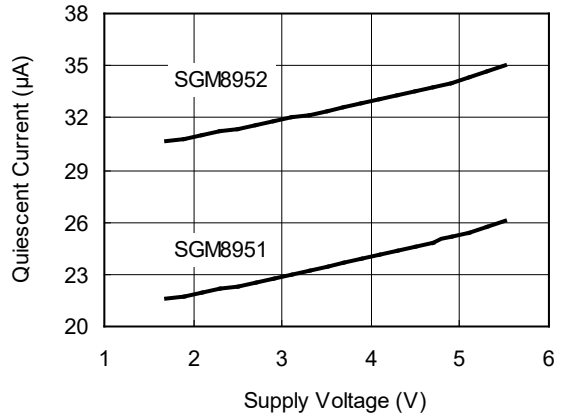
Common Mode Rejection Ratio vs. Temperature



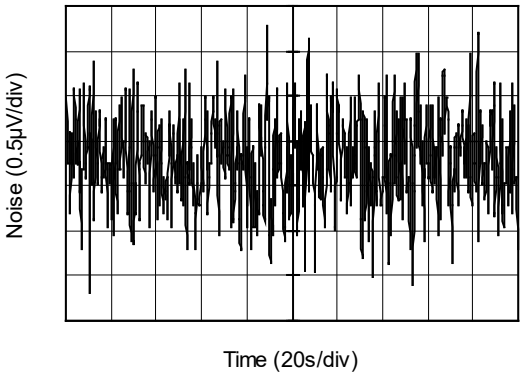
Pow er Supply Rejection Ratio vs. Temperature



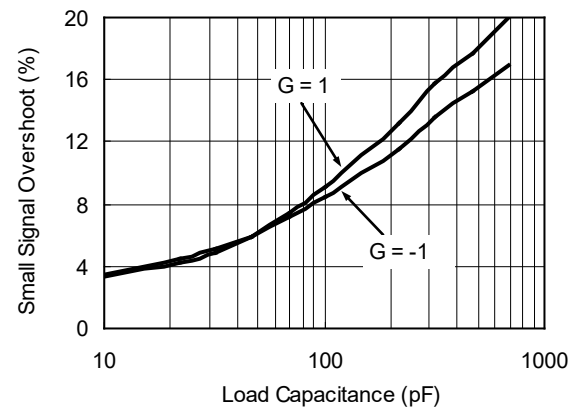
Quiescent Current vs. Supply Voltage



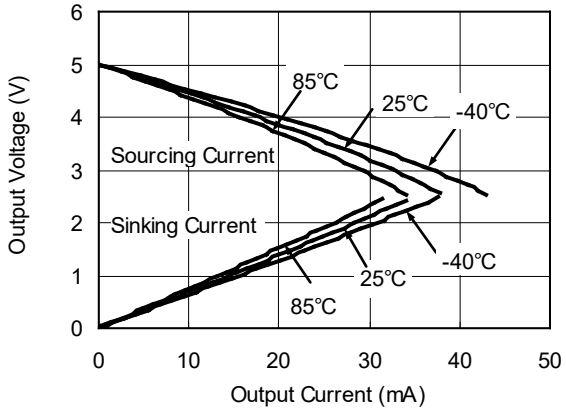
0.1Hz to 10Hz Noise at +5V



Small Signal Overshoot vs. Load Capacitance

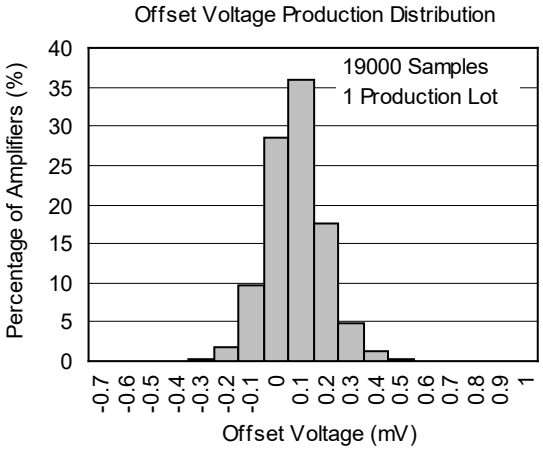


Output Voltage Sw ing vs. Output Current



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

At T_A = +25℃, V_S = 5V, unless otherwise noted.



REVISION HISTORY

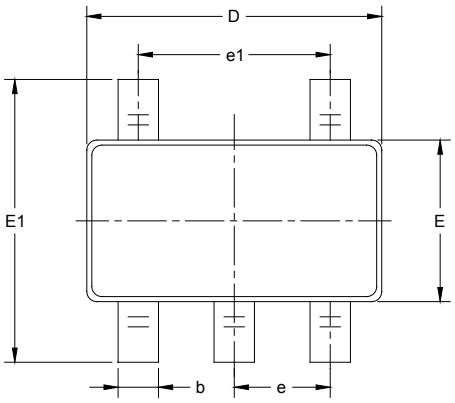
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

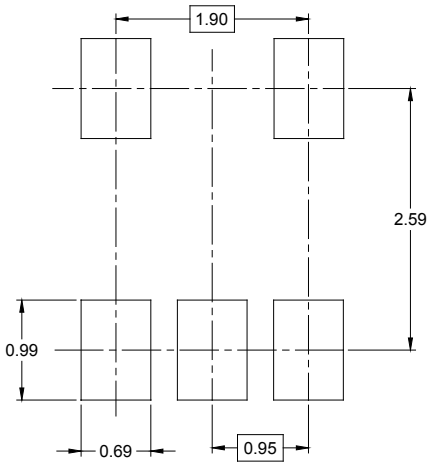
MAY 2013 – REV.A to REV.A.1	Page
Changed Electrical Characteristics section	4, 5

Changes from Original (DECEMBER 2012) to REV.A	Page
Changed from product preview to production data	All

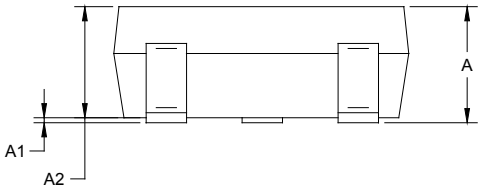
PACKAGE OUTLINE DIMENSIONS

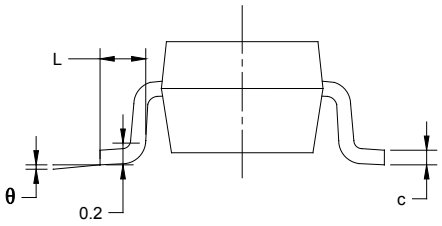
SOT-23-5





RECOMMENDED LAND PATTERN (Unit: mm)

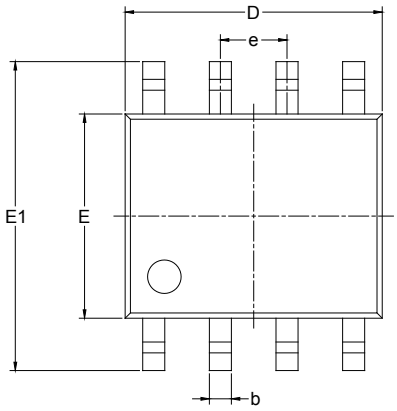


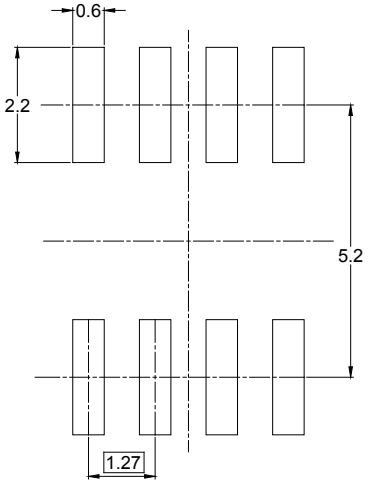


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 BSC		0.037 BSC	
e1	1.900 BSC		0.075 BSC	
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

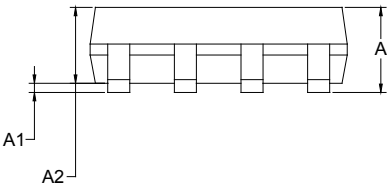
PACKAGE OUTLINE DIMENSIONS

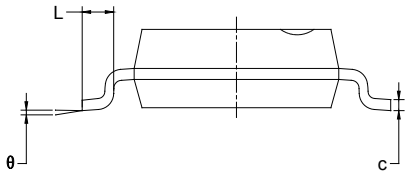
SOIC-8





RECOMMENDED LAND PATTERN (Unit: mm)

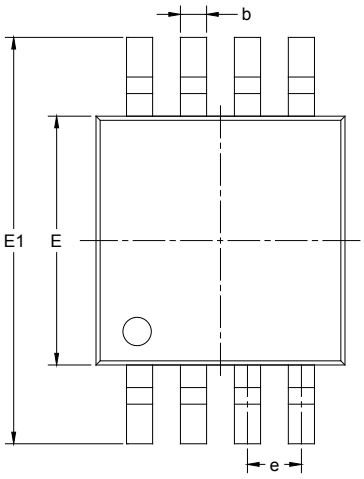


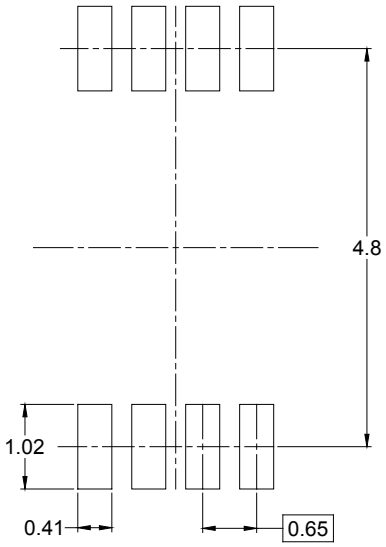


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.27 BSC		0.050 BSC	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

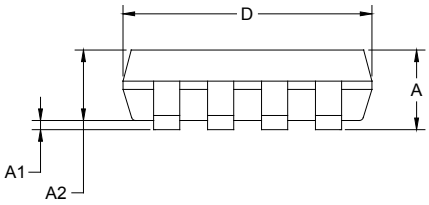
PACKAGE OUTLINE DIMENSIONS

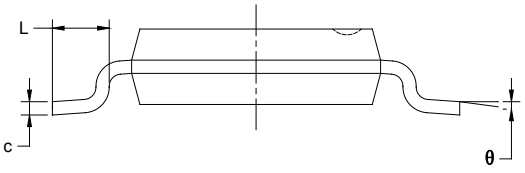
MSOP-8





RECOMMENDED LAND PATTERN (Unit: mm)

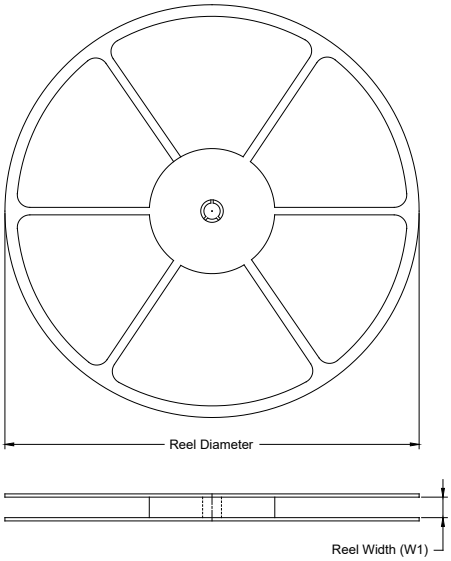




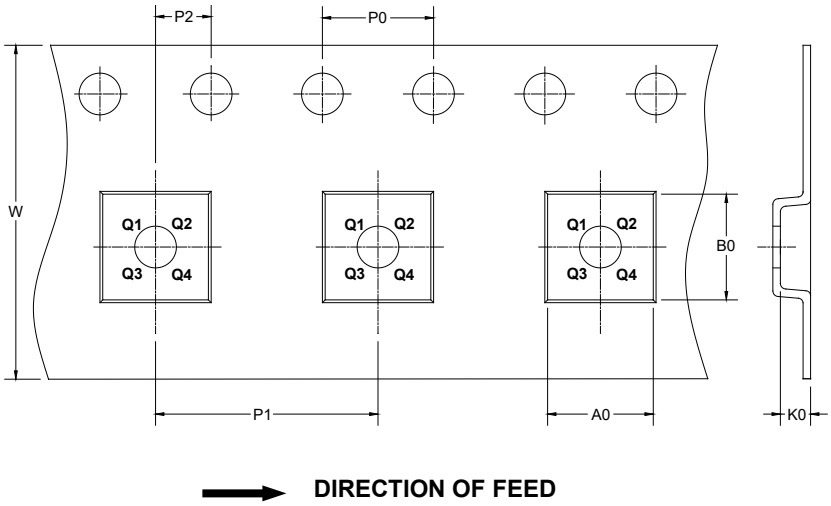
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
e	0.650 BSC		0.026 BSC	
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



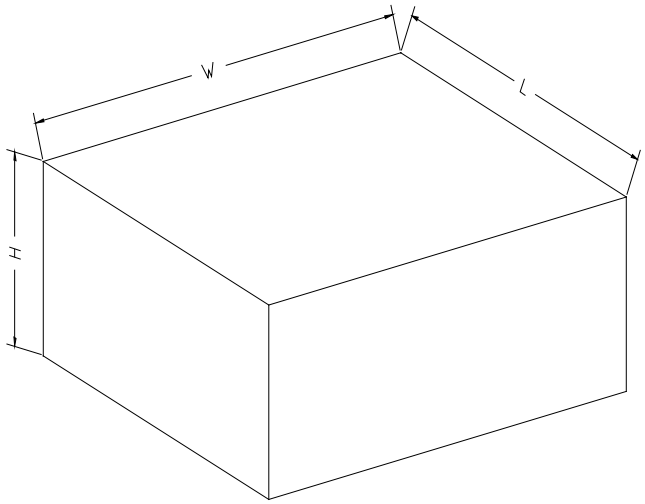
NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT-23-5	7″	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3
SOIC-8	13″	12.4	6.40	5.40	2.10	4.0	8.0	2.0	12.0	Q1
MSOP-8	13″	12.4	5.20	3.30	1.50	4.0	8.0	2.0	12.0	Q1

DD0001

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7″ (Option)	368	227	224	8
7″	442	410	224	18
13″	386	280	370	5

DD0002